

Custom Air-Cooled Switch OSFP





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400GBASE-SR4 OSFP Flat Top 850nm 100m MMF

400GbE OSFP SR4 liquid/immersion cooling transceiver (flat top), 3M MPO-12/APC Female Type A plug, 4x106.25GBd data lanes, for short-range MMF data

Choosing the Right OSFP: Balancing Performance and Thermal

Ideal for air-cooled OSFP switches, such as standard Ethernet switches relying on chassis fan airflow for cooling. Suited for hybrid cooling setups, like NVIDIA DGX H100 Cedar systems connecting to air



Thermal optimizations for osfp optical transceiver modules

Heat dissipation and electric shielding techniques and apparatuses are disclosed to enable the operation of octal small form factor pluggable (OSFP) modules at higher bandwidths. OSFP compatible

OSFP OCTAL SMALL FORM FACTOR PLUGGABLE MODULE

To allow for forced air cooling of the OSFP module, it is recommended there be ventilation holes in the top and back of the cages. Refer to Figure 30 and Figure 31 for examples of ventilation hole details.

MQM9790-NS2F, NVIDIA® 32 800G OSFP InfiniBand

This switch use connector cages that house two 400Gb/s ports in a single cage called



2x400G (800G) twin-port OSFP and are used exclusively in these air

OSFP OCTAL SMALL FORM FACTOR PLUGGABLE MODULE

Abstract: This specification defines the electrical connectors, electrical signals and power supplies, mechanical and thermal requirements of the OSFP Module, connector and cage systems. The OSFP

OSFP Optical Module Thermal Design: Structure, Heat Dissipation

Two-phase/immersion solutions: For ultra-high power densities (800G+ or multi-module blade designs), two-phase immersion or liquid cooling becomes a practical option -- vendors already



Solving Cooling Interconnects for Next-Gen Data

High-performance data center and AI workloads are power-intensive, outpacing efficiency improvements in air-cooling technology. Power requirements

Connectors and Cages

800G flat-top, twin-port, 8-channel, 2x400G OSFP for linking DGXH100 Cedar7 GPU links which use internal cage riding, air-cooled, heat sinks for liquid-cooled systems.

OSFP Thermal Solutions , Cofan Thermal

Cofan's air-cooled OSFP thermal modules are engineered to meet the growing thermal demands of next-generation AI servers and high-speed telecommunications infrastructure.



A Comprehensive Guide of the Thermal Design in OSFP Modules

Combining the thermal characteristics of both finned-top and flat-top designs, it is suitable for air-cooled switches, liquid-cooling systems, or environments where dust protection is required.

OSFP OCTAL SMALL FORM FACTOR PLUGGABLE MODULE

To allow for forced air cooling of the OSFP module, it is recommended there be ventilation holes in the top and back of the cages. Refer to Figure 4-10 and Figure 4-11 for examples of ventilation hole details.



QSFP-DD vs OSFP: Which 400G/800G Form Factor

Compare QSFP-DD and OSFP. Learn about size, compatibility, cooling, density, and use cases. Includes comparison tables, deployment advice,

A Comprehensive Guide of the Thermal Design in OSFP Modules

The design incorporates a layer of metal cover over the heat dissipation fins, which provides mechanical rigidity and EMI shielding. Combining the thermal characteristics of both finned

From Airflow to Liquid Cooling: A Deep Dive into 800G

Designed for air-cooled switches, especially traditional rack-mounted Ethernet switches.



Improves cooling efficiency in airflow channels, ensuring

Thermal optimizations for OSFP optical transceiver modules

Heat dissipation and electric shielding techniques and apparatuses are disclosed to enable the operation of OSFP modules at higher bandwidths. OSFP compatible techniques are

OSFP-XD MSA Rev 1.1

An OSFP-XD-RHS cage has a lower height than an OSFP-XD cage and makes use of a riding heat sink for cooling. The forward stop feature in an OSFP-XD-RHS cage is shifted compared with an OSFP



OSFP1600_and_OSFP-XD

The OSFP-XD RHS solution is not intended to support copper cable applications and is not expected to achieve the same thermal capabilities as the IHS solution unless alternative cooling techniques are

Unlocking High-Performance Cooling with Amphenol's

Whether it's integrating a liquid cooling system into an existing application or creating a custom connector and cable solution, Amphenol

OSFP CONNECTORS, CAGES & CABLE ASSEMBLIES

TE Connectivity's (TE) Octal Small Form Factor Pluggable (OSFP) connectors, cages and cable assemblies address next-generation data center needs by supporting aggregate



data rates of 200

OSFP-IHS vs. OSFP-RHS: Choosing the Right Thermal Solution for

Compare OSFP-IHS and OSFP-RHS thermal designs for 800G and 1.6T optical modules. Learn how to choose the right OSFP solution for air-cooled, liquid-cooled, and AI data center

OSFP MSA Rev 5

An OSFP/OSFP800 or OSFP1600 module (see section 3, section 4 and section 11) includes an air-cooled integrated heatsink (IHS) with a closed top (see section 3.3) or an open top (see section 3.4),



NVIDIA Quantum-X800 Q3200-RA 36 XDR Ports over

NVIDIA Quantum-X800 Q3200 2U air-cooled configuration switch is ideal for smaller-scale platforms or integration with existing infrastructure. This system houses two

OSFP Connectors 2025: Design, QSFP-DD

While QSFP-DD remains common, the OSFP (Octal Small Form-Factor Pluggable) has emerged as a strong contender, designed from the ground

OSFP Connector System

The Octal Small Form Factor Pluggable (OSFP) Connector System provides single- or dual-port, 8- or 16-lane I/O connectivity with DAC, AOC, ACC and optical



OSFP IHS vs OSFP RHS: Thermal Design and Key

In the OSFP standard, IHS and RHS represent two different heat dissipation paths, which differ significantly in structural design, thermal

Contact Us

For datasheets, pricing, or custom optical networking solutions, please visit:
<https://www.entrenamientointeligente.es>